AND TRADEMARK OFFICE

Attorney Docket No.: ROH-0026

Coleman

IN THE UNITED STATES PATENT AND TRADEMARK OFFIÇE

In re the Application of:

S. UEDA

Application No.: 09/665,663

Filed: September 20, 2000

SEMICONDUCTOR CHIP AND METHOD OF PRODUCING THE SAME

AMENDMENT TRANSMITTAL

MMISSIONER FOR PATENTS

Washington, D.C. 20231

Date: March 12, 2002

Sir:

Transmitted herewith is an Amendment in the above-identified application.

No additional fee is required. \boxtimes

The fee has been calculated as shown below

				CL	AIMS AS A	MEN	DED			
	REM.	AIMS AINING TER IDMENT	HIGHEST PREVIOU PAID	SLY	PRESENT EXTRA	EN	ALL TITY ATE		OTHER THAN A SMALL ENTITY	ADDITIONAL FEE
TOTAL CLAIMS	10	MINUS	20	=	0	х	\$9	OR	\$18	\$0.00
INDEP. CLAIMS	4	MINUS	4	=	0	х	\$42	OR	\$84	\$0.00
Fee for Multiple Dependent Claims \$140/\$280 OR							,			
					TOTAL ADDI	TIONAL	FEE FO	OR THIS	AMENDMENT	\$84.00

A Letter to the Office	cial Draftsperson is enclosed.
An Associate Powe	r of Attorney and Change of Name and Address is enclosed.
Charge \$sheet is enclosed.	to Deposit Account No. 18-0013. A duplicate copy of this

S. UEDA Application No. 09/665,663 Attorney Docket No.: ROH-0026

	Any prior general authorization to charge an Issue Fee under 37 C.F.R. 1.18 to Deposit Account No. 18-0013 is hereby revoked. The Commissioner is hereby authorized to charge any additional fees under 37 CFR 1.16 and 1.17 which may be required during the entire pendency of this application, or to credit any overpayment, to Deposit Account No. 18-0013. A duplicate copy of this sheet is enclosed.
	Charge \$to Deposit Account No. 18-0013 to cover the Extension fee for response withinmonth(s).
\boxtimes	Applicant's undersigned attorney may be reached by telephone in our Washington D.C. Office at (202) 955-3750.
	All correspondence should be directed to our below listed address.
	Respectfully submitted.

RADER, FISHMAN & GRAUER PLLC

1233 20th Street, N.W. Suite 501 Washington, D.C. 20036

Tel: (202) 955-3750 Fax: (202) 955-3751 Customer No. 23353

Enclosure(s):

Amendment Under 37 C.F.R. §1.111

Claim to Priority under 35 USC 119

Priority Document (Japanese Patent Appl. No. 11-265744)

Reg. No. 29,211

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of:

Attorney Docket No.: ROH-0026

S. UEDA

Application No.: 09/665,663

Examiner: W. D. Coleman

Filed: September 20, 2000

Art Unit: 2823

For: SEMICONDUCTOR CHIP AND METHOD OF PRODUCING THE SAME

AMENDMENT UNDER 37 C.F.R. §1.111

Mmissioner for Patents Washington, DC 20231 Date: March 12, 2002

Sir:

In response to the Office Action dated December 21, 2001, please amend the above-identified application as follows:

IN THE CLAIMS:

Please amend claims 3, 5, 6 and 7 as set forth below in clean form. Additionally, in accordance with 37 CFR 1.121(c)(1)(ii), the amended claim(s) is/are set forth in a marked-up version in the page(s) attached to this Amendment.

3. (Amended) The semiconductor chip according to claim 2, further comprising

an internal connection pad which is formed by partially exposing said the internal wiring from said surface protective film in a portion of different from said external connection pad, and

an electrical contact projection formed in a raised state on the internal connection pad using a metal material having oxidation resistance in order to make electrical connection to the said solid device.

5. (Amended) The semiconductor chip according to claim 3, wherein

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